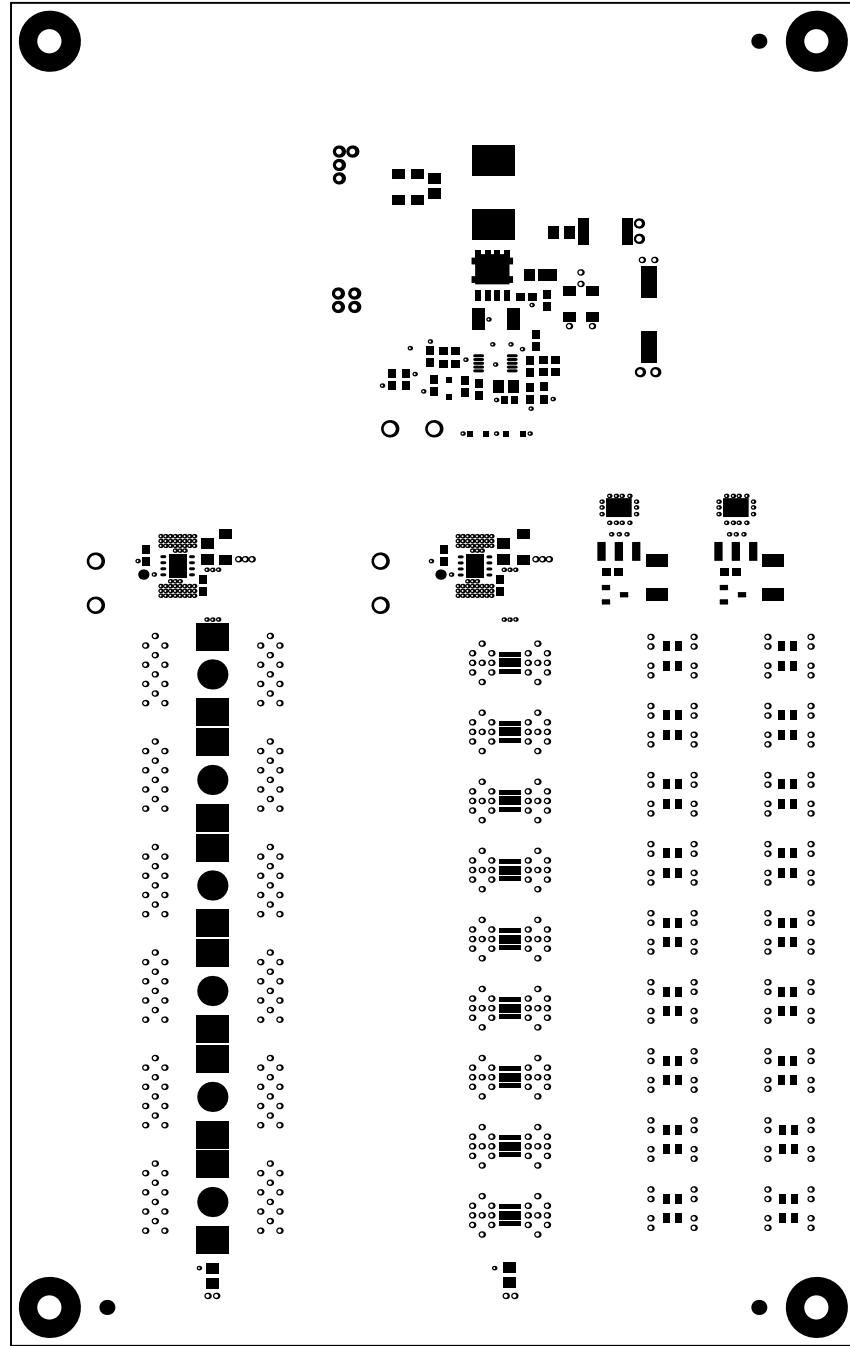
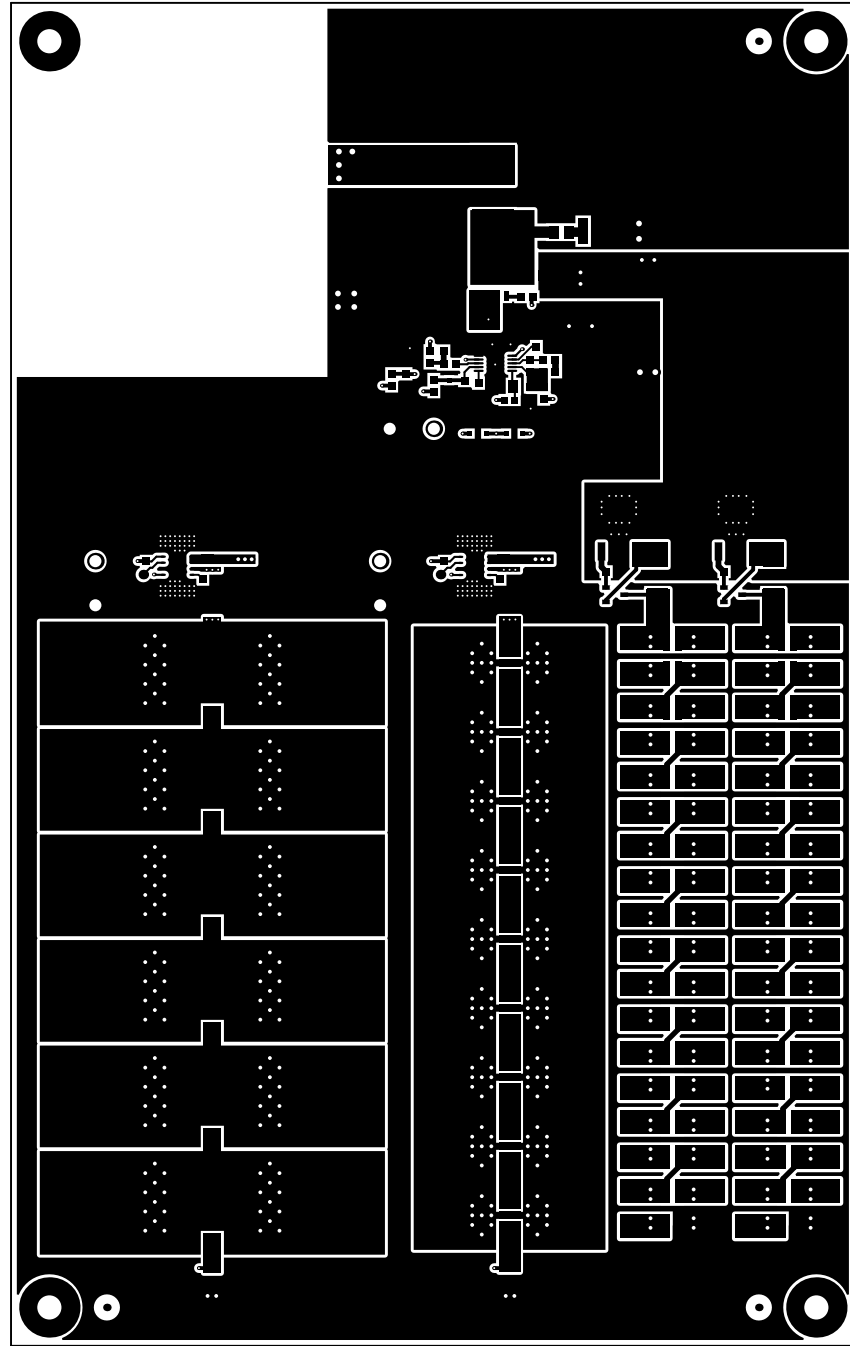


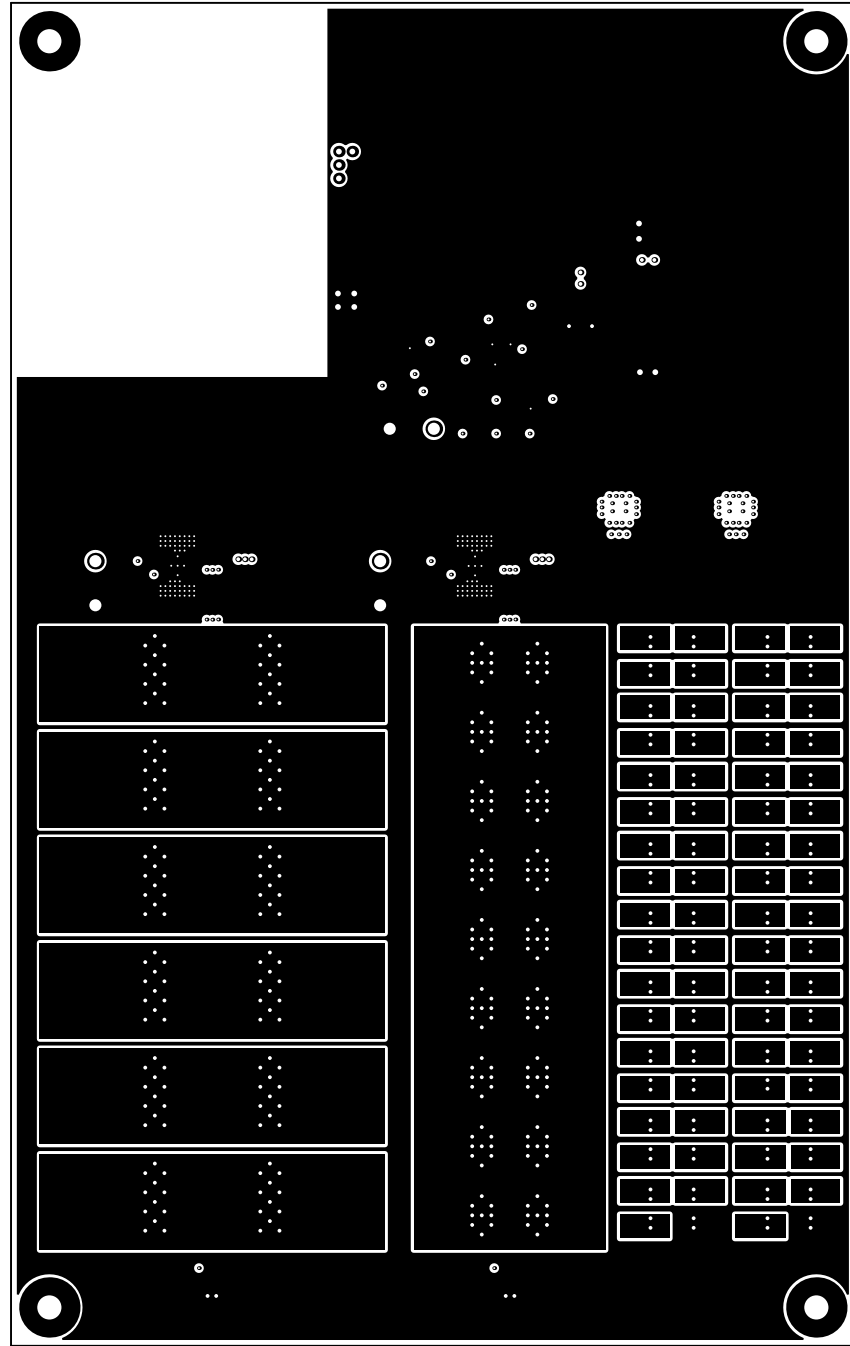
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP20305		
PLOT NAME = Top Overlay	GENERATED : 11/30/2017 10:02:20 AM	TEXAS INSTRUMENTS	



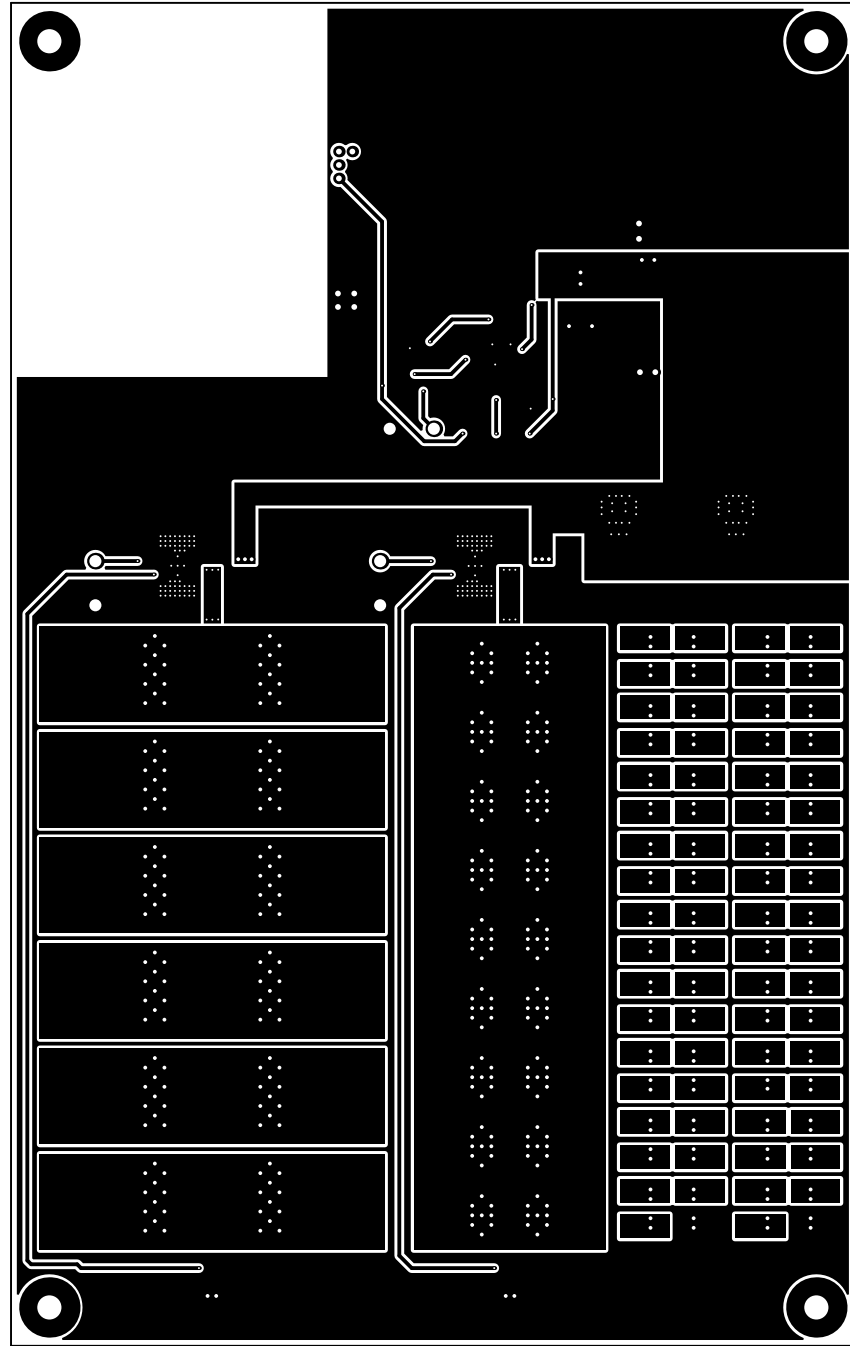
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP20305		
PLOT NAME = Top Solder Mask	GENERATED : 11/30/2017 10:02:21 AM	TEXAS INSTRUMENTS	



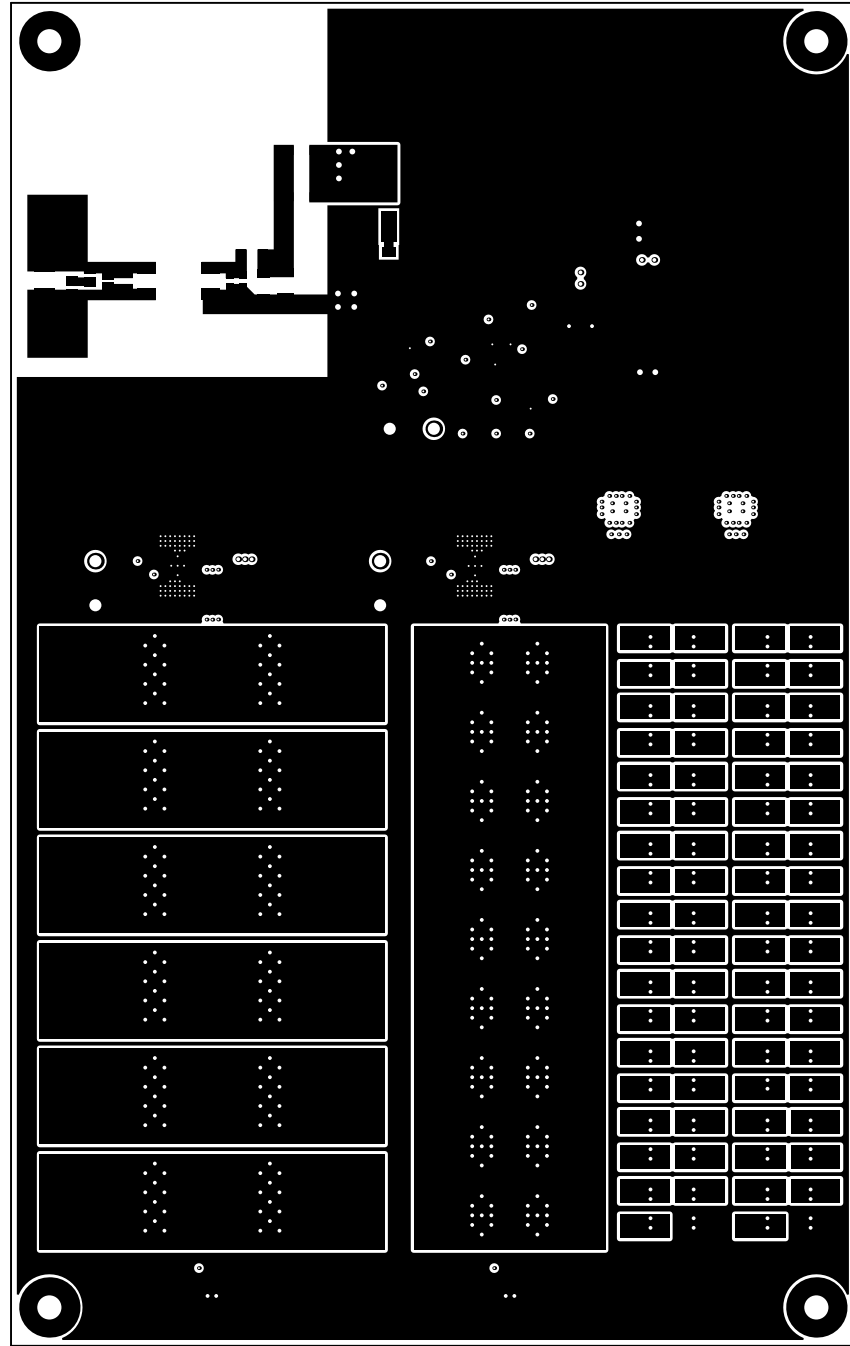
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP20305		
PLOT NAME = Top Layer	GENERATED : 11/30/2017 10:02:22 AM	TEXAS INSTRUMENTS	



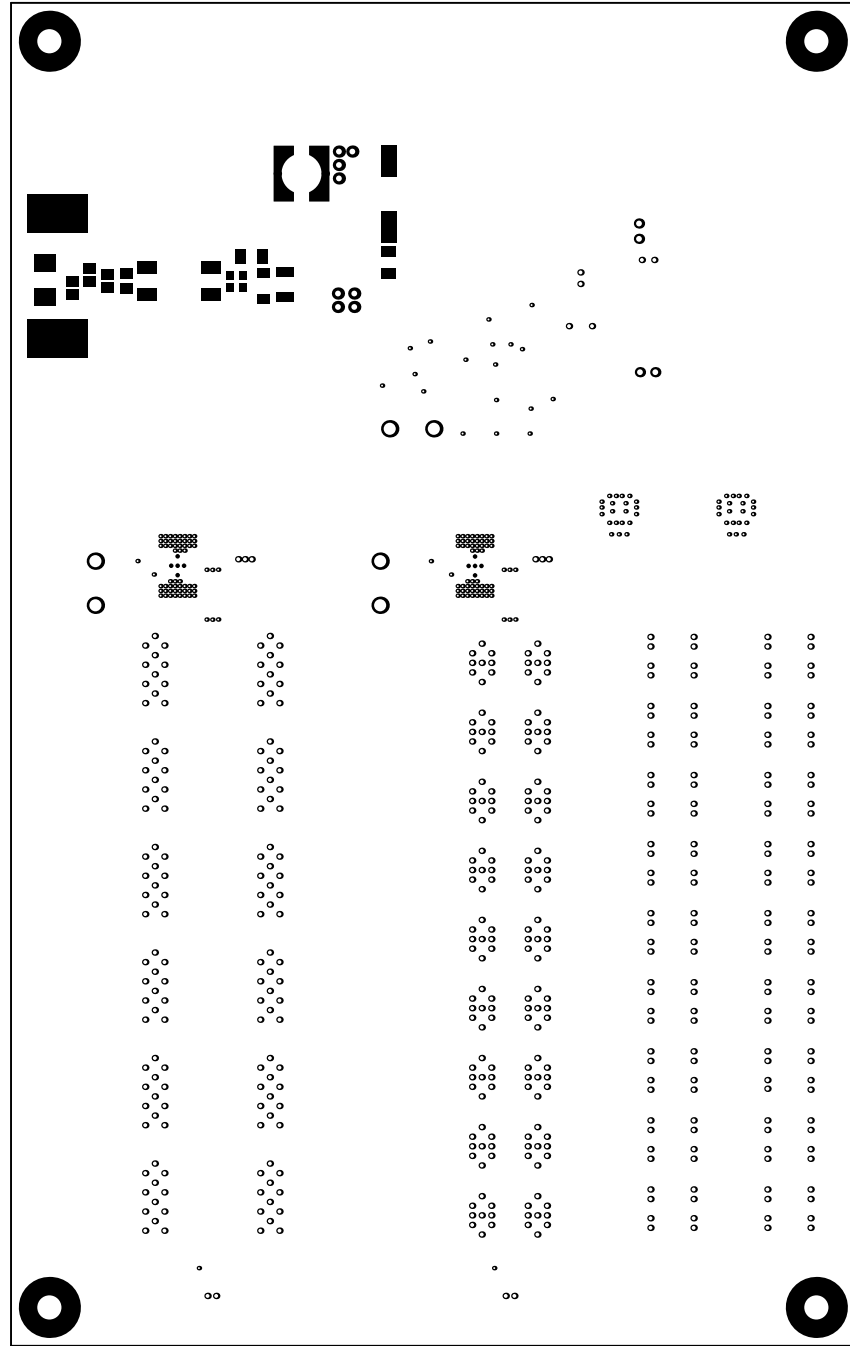
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP20305		
PLOT NAME = Signal Layer 1	GENERATED : 11/30/2017 10:02:23 AM	TEXAS INSTRUMENTS	



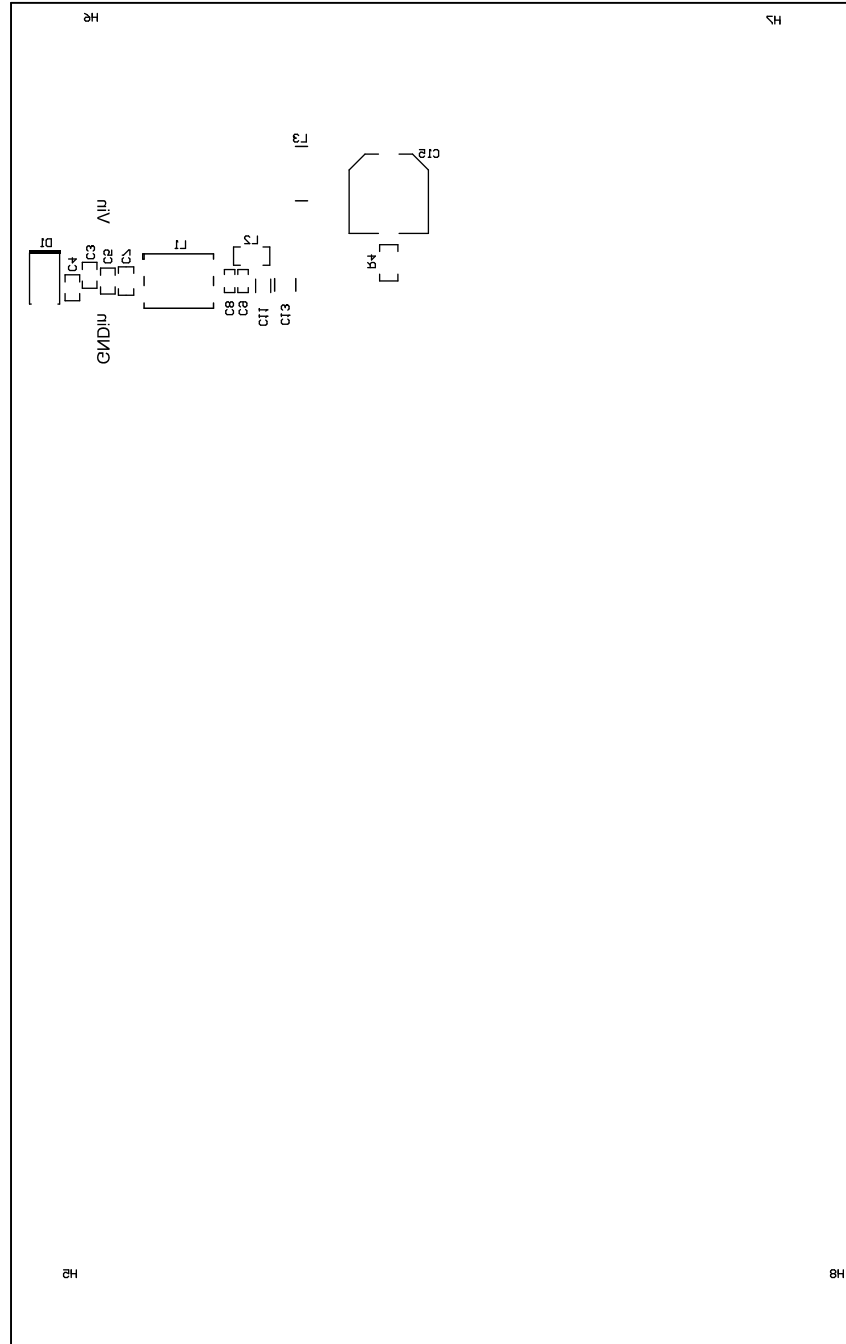
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP20305		
PLOT NAME = Signal Layer 2	GENERATED : 11/30/2017 10:02:23 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP20305		
PLOT NAME = Bottom Layer	GENERATED : 11/30/2017 10:02:24 AM	TEXAS INSTRUMENTS	

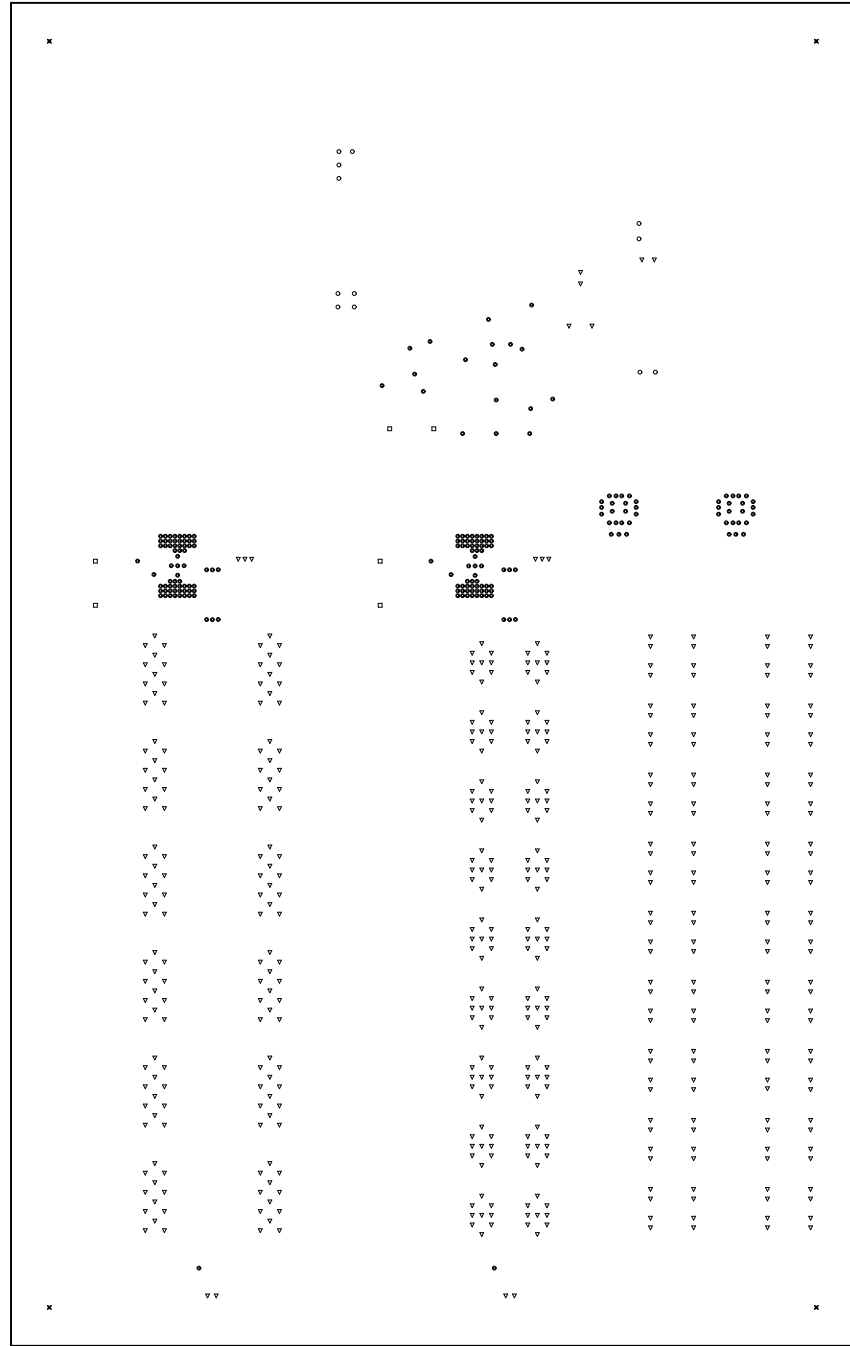


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP20305		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/30/2017 10:02:25 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: PMP20305		
PLOT NAME = Bottom Overlay	GENERATED : 11/30/2017 10:02:25 AM	TEXAS INSTRUMENTS	

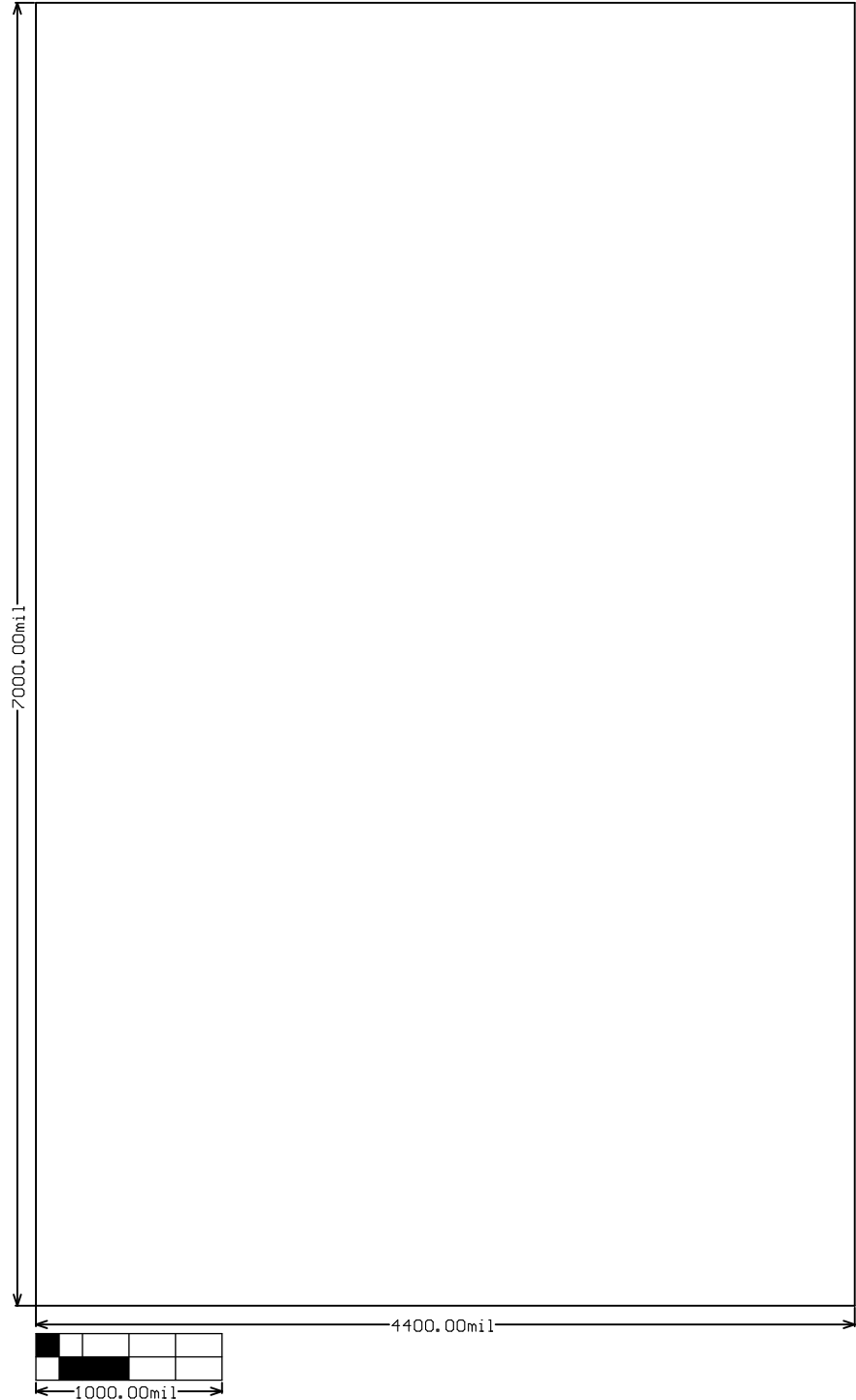




Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	10	7.87mil (0.200mm)	PTH	Round
▽	2	214.57mil (5.450mm)	PTH	Round
	12 Total			

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
●	196	10.00mil (0.254mm)	PTH	Round
▽	466	20.00mil (0.508mm)	PTH	Round
○	12	30.00mil (0.762mm)	PTH	Round
□	6	63.00mil (1.600mm)	PTH	Round
✕	4	125.98mil (3.200mm)	PTH	Round
	684 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP20305		
PLOT NAME = Drill Drawing	GENERATED : 11/30/2017 10:02:26 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20305	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP20305		
PLOT NAME = Board Dimensions	GENERATED : 11/30/2017 10:02:27 AM	TEXAS INSTRUMENTS	

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